

• General Description

The AGMH065N10A combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$.

This device is ideal for load switch and battery protection applications.

Features

- Advance high cell density Trench technology
- Low R_{DS(ON)} to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

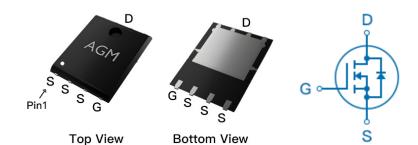
Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

BVDSS	RDSON	ID
100V	5.8mΩ	95A

PDFN5*6 Pin Configuration



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGMH065N10A	AGMH065N10A	PDFN5*6	330mm	12mm	3000

Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	100	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	95	А
	Drain Current-Continuous(Tc=100℃)	56	Α
IDM (pluse)	Drain Current-Pulsed (Note 2)	380	А
PD	Maximum Power Dissipation(Tc=25℃)	125	w
	Maximum Power Dissipation(Tc=100℃)	50	w
EAS	Avalanche energy (Note 3)	324	mJ
TJ,TSTG Operating Junction and Storage Temperature Range		-55 To 150	$^{\circ}$

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹		20	°C/W
RθJC	Thermal Resistance Junction-Case ¹		1.0	°C/W



Table 3. Electrical Characteristics (TJ=25 ℃ unless otherwise noted)

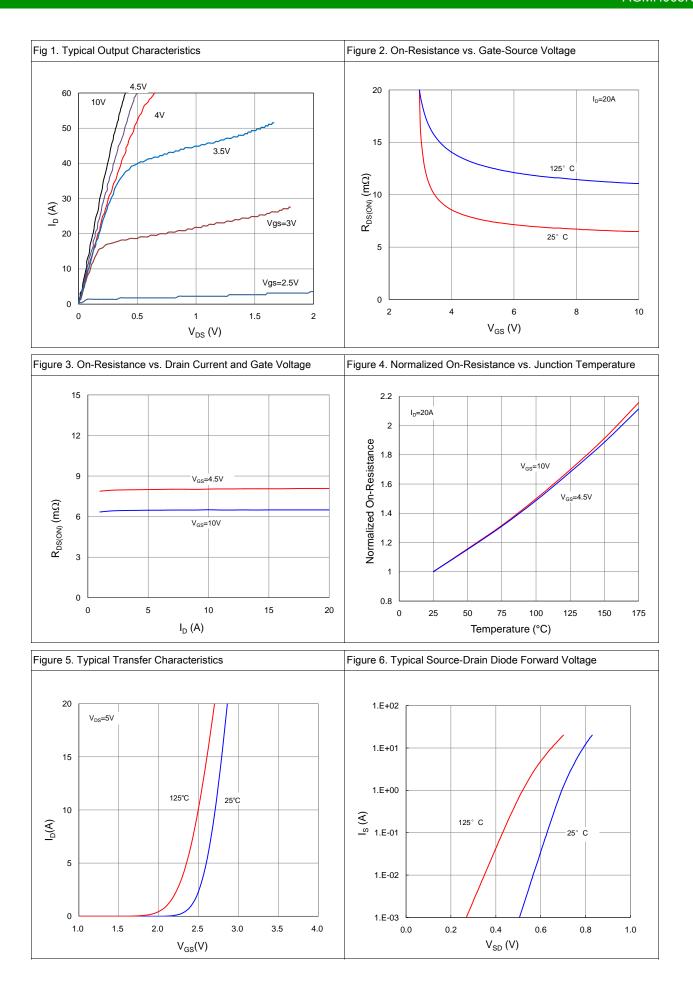
Fable 3. Electrical Characteristics (TJ=25 ℃ unless otherwise noted)						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off St	ates					
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	100			V
IDSS	Zero Gate Voltage Drain Current	VDS=100V,VGS=0V			1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	2.0	3.0	4.0	٧
gFS	Forward Transconductance	VDS=5V,ID=15A		19		S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=20A		5.8	7.8	mΩ
Dynamic	Characteristics					
Ciss	Input Capacitance			1830		pF
Coss	Output Capacitance	VDS=40V,VGS=0V ,F=1MHZ		750		pF
Crss	Reverse Transfer Capacitance	_ ,,		18		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz		1.6		Ω
Switching	g Times		•			
td(on)	Turn-on Delay Time			14		nS
tr	Turn-on Rise Time	VGS=10V,VDS=50V,		6		nS
td(off)	Turn-Off Delay Time	ID=6A,RGEN=10Ω		28		nS
tf	Turn-Off Fall Time			5		nS
Qg	Total Gate Charge			35		nC
Qgs	Gate-Source Charge	VGS=10V, VDS=30V, ID=12A		18		nC
Qgd	Gate-Drain Charge	- 10-12/		7.5		nC
Source-D	rain Diode Characteristics		•	•		
ISD	Source-Drain Current(Body Diode)				95	Α
VSD	Forward on Voltage	VGS=0V,IS=20A		0.85	1.2	V
trr	Reverse Recovery Time	IF=20A ,VDD=50V				ns
Qrr	Reverse Recovery Charge	dl/dt=100A/µs , TJ=25℃				nc

Notes 1. The maximum current rating is package limited.

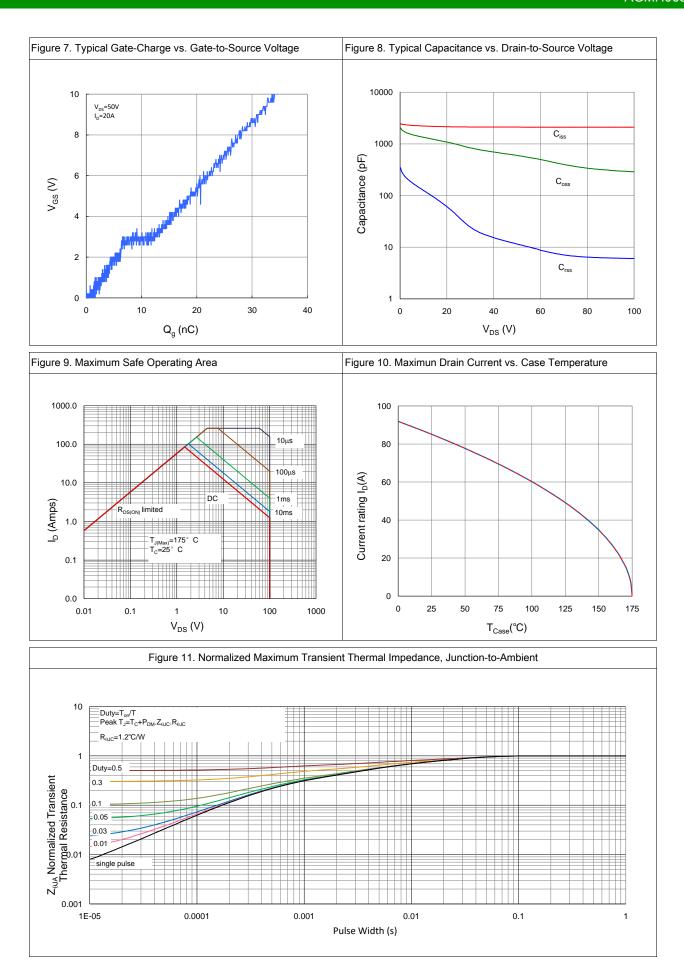
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25 $^{\circ}$ C,VDD=50V,Vgs=10V,ID=36A,L=0.5mH,RG=25ohm



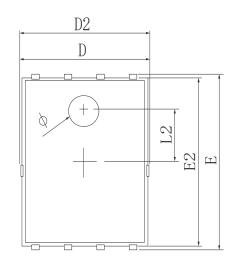


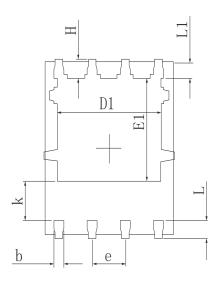


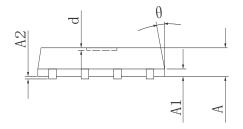




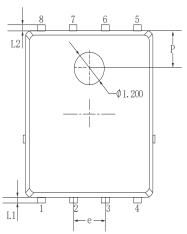
•Dimensions (PDFN5*6)

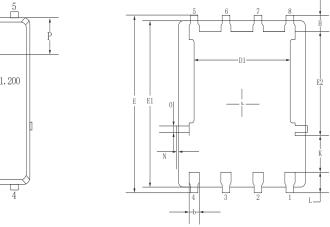


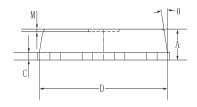




oramor.		MILLIMETER		
SYMBOL	MIN	Тур.	MAX	
A	0.900	1.000	1.100	
A1		0.254 REF.		
A2		0~0.05		
D	4. 824	4.900	4.976	
D1	3.910	4.010	4.110	
D2	4. 924	5. 000	5. 076	
Е	5. 924	6.000	6.076	
E1	3. 375	3. 475	3. 575	
E2	5. 674	5. 750	5. 826	
b	0.350	0.400	0.450	
е		1.270 TYP.		
L	0.534 0.610 0.6			
L1	0.424	0.500	0.576	
L2	1.800 REF.			
k	1.190	1.290	1.390	
Н	0.549	0.625	0.701	
θ	8°	10°	12°	
Ф	1.100	1.100 1.200 1.300		
d			0.100	





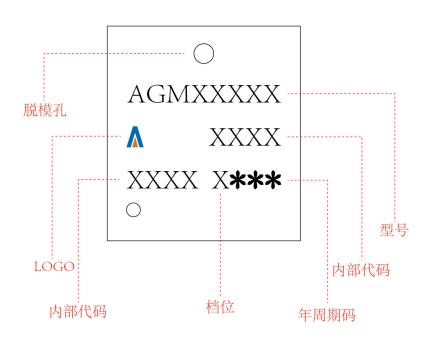


	Millimeters	
MIN.	NOM.	MAX.
0.90	1.05	1. 20
0.35	0.40	0.50
0.20	0. 25	0.35
4.90	5. 05	5. 20
3. 72	3. 82	3. 92
6.00	6. 15	6. 30
5. 60	5. 75	5. 90
3. 47	3. 57	3. 67
	1.27 BSC.	
0.48	0.58	0.68
1. 17	1. 27	1. 37
0.64	0.74	0.84
0.20 REF.		
8°	10°	12°
0.08 REF.		
0	-	0. 15
	0.25 REF.	
	1.28 REF.	
	MIN. 0. 90 0. 35 0. 20 4. 90 3. 72 6. 00 5. 60 3. 47 0. 48 1. 17 0. 64	0.90 1.05 0.35 0.40 0.20 0.25 4.90 5.05 3.72 3.82 6.00 6.15 5.60 5.75 3.47 3.57 1.27 BSC. 0.48 0.58 1.17 1.27 0.64 0.74 0.20 REF. 8° 10° 0.08 REF. 0 -

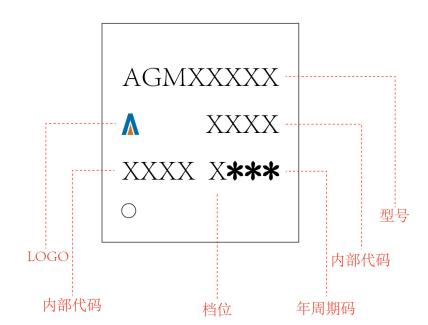


PDFN5*6 Marking Instructions:

Model1:



Model2:





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